

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
	Name	Execution Date
	AYANO KON	04/09/2019
RECEIVING PARTY DATA		
Name:	ENPLAS CORPORATION	
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City:	SAITAMA	
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PROPERTY NUMBERS Total: 1		
Property Type	Number	
Application Number:	16468302	
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NAME OF SUBMITTER:	CARL I. BRUNDIDGE	
SIGNATURE:	/CARL I. BRUNDIDGE/	
DATE SIGNED:	06/11/2019	
Total Attachments: 1		
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ASSIGNMENT

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to the undersigned by Enplas Corporation, A corporation organized under the laws of Japan and located at 2-30-1, Namiki, Kawaguchi-shi, Saitama 332-0034 Japan, receipt of which is hereby acknowledged, I or we do hereby sell and assign to said Enplas Corporation, its successors and assigns, all of my right, title and interest, in and for the United States of America in and to the invention entitled

OPTICAL RECEPTACLE, OPTICAL MODULE, AND METHOD FOR MANUFACTURING OPTICAL MODULE invented by me or us and described in the application for U.S. Letters Patent therefor identified as:

(☒) Serial No. PCT/JP2017/040852, filed November 14, 2017; or

(☐) executed on even date herewith; or

(☐) executed on (date) _____,

and all United States Letters Patent which may be granted therefor, and all Divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by Enplas Corporation, its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted, as fully and entirely as the same would have been held and enjoyed by the me or us if this assignment and sale had not been made;

And I or we hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of said above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reexamination or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the joint title thereto in said assignee;

And I or we do hereby authorize and request the Commissioner of Patents and Trademarks, or equivalent, to issue said Letters Patent to said Enplas Corporation and do hereby authorize the Law Firm of Brundidge & Stanger, P.C. to insert on this assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document.

Signed on the date(s) indicated aside signatures:

INVENTOR(S)

Date Signed

1)

今中 邦子
Ayano KON

Apr. 9, 2019